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(54) HEAT TREATABLE L12 ALUMINUM ALLOYS

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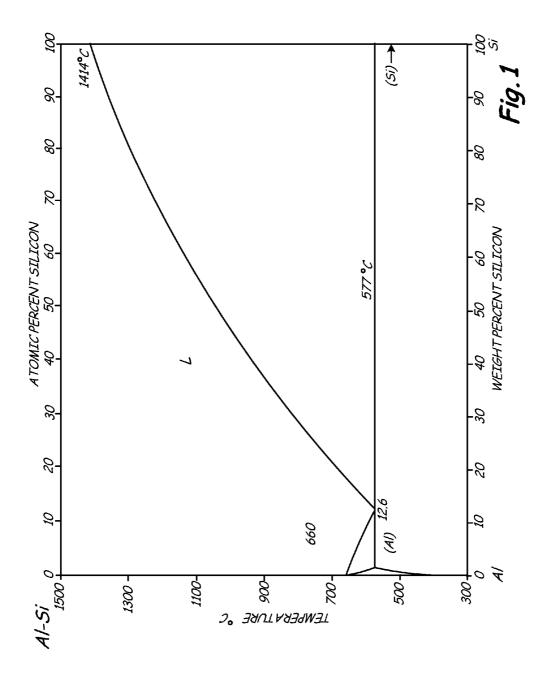
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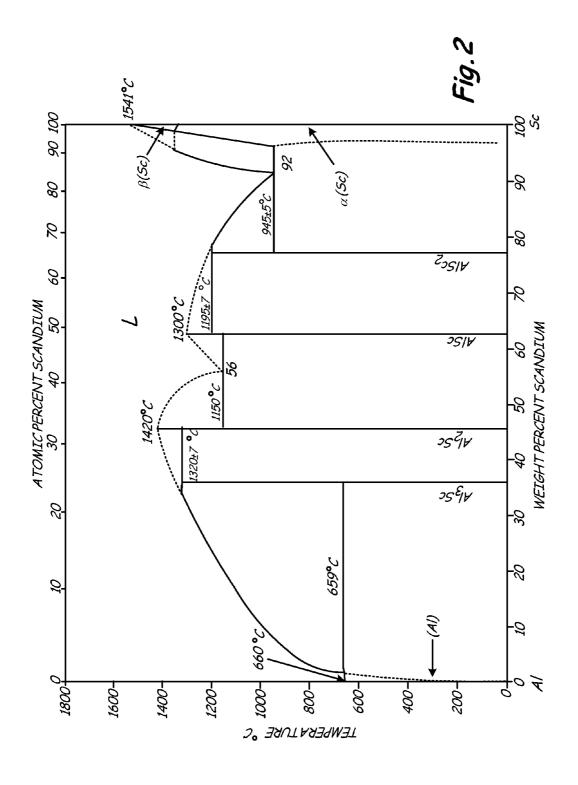
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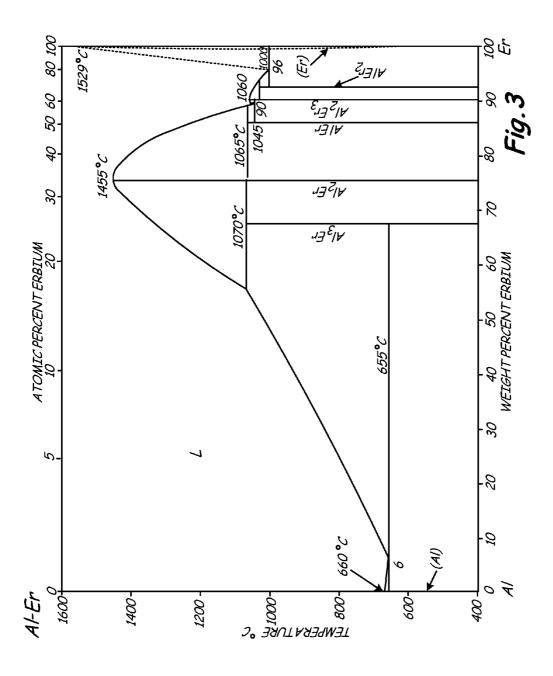
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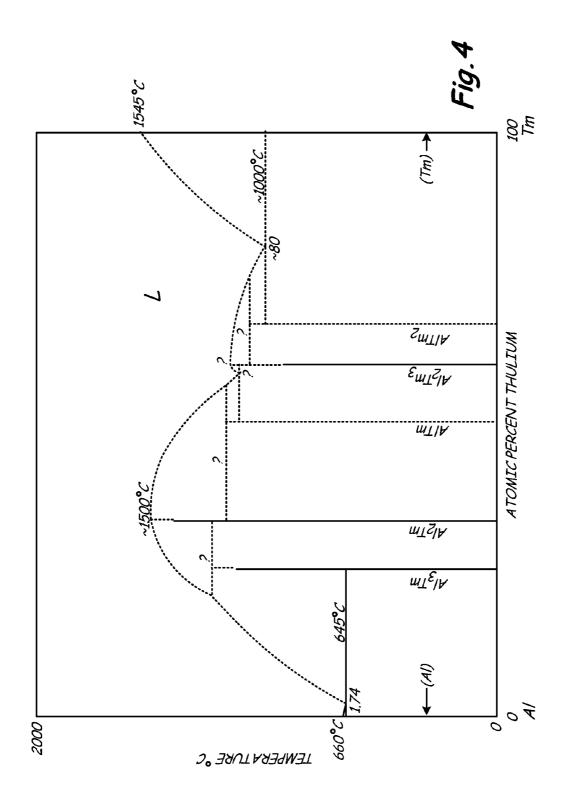
(57) ABSTRACT

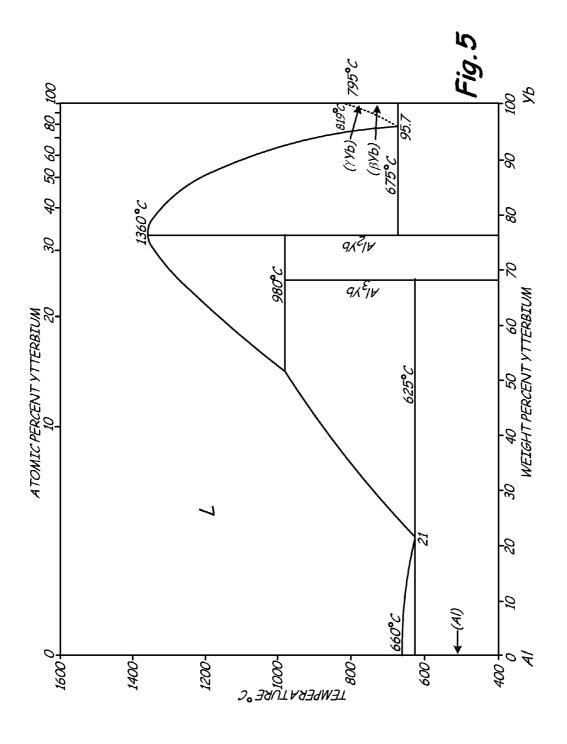
High temperature heat treatable aluminum alloys that can be used at temperatures from about -420° F. $(-251^{\circ}$ C.) up to about 650° F. $(343^{\circ}$ C.) are described. The alloys are strengthened by dispersion of particles based on the L1₂ intermetallic compound Al₃X. These alloys comprise aluminum; silicon; at least one of scandium, erbium, thulium, ytterbium, and lutetium; and at least one of gadolinium, yttrium, zirconium, titanium, hafnium, and niobium. Magnesium and copper are optional alloying elements.

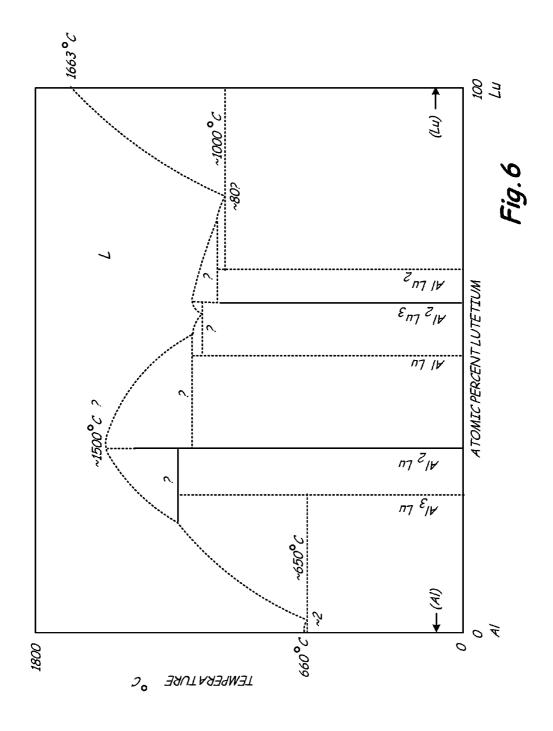












HEAT TREATABLE L12 ALUMINUM ALLOYS

CROSS-REFERENCE TO RELATED APPLICATIONS

[0001] This application a divisional of U.S. patent application Ser. No. 12/148,383, filed Apr. 18, 2008, which is related to the following co-pending applications that were filed on even date therewith and were assigned to the same assignee: L12 ALUMINUM ALLOYS WITH BIMODAL AND TRI-MODAL DISTRIBUTION, Ser. No. 12/148,395, Attorney Docket No. PA0006933U-U73.12-325KL; DISPERSION STRENGTHENED L12 ALUMINUM ALLOYS, Ser. No. 12/148,432, Attorney Docket No. PA0006932U-U73.12-326KL; HIGH STRENGTH L12 ALUMINUM ALLOYS, Ser. No. 12/148,394, Attorney Docket No. PA0006929U-U73.12-329KL; HIGH STRENGTH L12 ALUMINUM ALLOYS, Ser. No. 12/148,382, Attorney Docket No. PA0006928U-U73.12-330KL; HEAT TREATABLE L1, ALUMINUM ALLOYS, Ser. No. 12/148,396, Attorney PA0006927U-U73.12-331KL; No. STRENGTH L1₂ ALUMINUM ALLOYS, Ser. No. 12/148, 387, Attorney Docket No. PA0006926U-U73.12-332KL; HIGH STRENGTH ALUMINUM ALLOYS WITH L1, PRECIPITATES, Ser. No. 12/148,426, Attorney Docket No. PA0006924U-U73.12-334KL; HIGH STRENGTH L1, ALUMINUM ALLOYS, Ser. No. 12/148,459, Attorney Docket No. PA0006923U-U73.12-335KL; and L1₂ STRENGTHENED AMORPHOUS ALUMINUM ALLOYS, Ser. No. 12/148,458, Attorney Docket No. PA0001359U-U73.12-336KL.

BACKGROUND

[0002] The present invention relates generally to aluminum alloys and more specifically to heat treatable aluminum alloys produced by melt processing and strengthened by $\rm L1_2$ phase dispersions.

[0003] The combination of high strength, ductility, and fracture toughness, as well as low density, make aluminum alloys natural candidates for aerospace and space applications. However, their use is typically limited to temperatures below about 300° F. (149° C.) since most aluminum alloys start to lose strength in that temperature range as a result of coarsening of strengthening precipitates.

[0004] The development of aluminum alloys with improved elevated temperature mechanical properties is a continuing process. Some attempts have included aluminumiron and aluminum-chromium based alloys such as Al—Fe—Ce, Al—Fe—V—Si, Al—Fe—Ce—W, and Al—Cr—Zr—Mn that contain incoherent dispersoids. These alloys, however, also lose strength at elevated temperatures due to particle coarsening. In addition, these alloys exhibit ductility and fracture toughness values lower than other commercially available aluminum alloys.

[0005] Other attempts have included the development of mechanically alloyed Al—Mg and Al—Ti alloys containing ceramic dispersoids. These alloys exhibit improved high temperature strength due to the particle dispersion, but the ductility and fracture toughness are not improved.

[0006] U.S. Pat. No. 6,248,453 discloses aluminum alloys strengthened by dispersed Al_3X $L1_2$ intermetallic phases where X is selected from the group consisting of Sc, Er, Lu, Yb, Tm, and U. The Al_3X particles are coherent with the aluminum alloy matrix and are resistant to coarsening at

elevated temperatures. The improved mechanical properties of the disclosed dispersion strengthened L1₂ aluminum alloys are stable up to 572° F. (300° C.). In order to create aluminum alloys containing fine dispersions of Al₃X L1₂ particles, the alloys need to be manufactured by expensive rapid solidification processes with cooling rates in excess of 1.8×10^3 F/sec (10^3 C/sec). U.S. Patent Application Publication No. 2006/0269437 discloses an aluminum alloy that contains scandium and other elements. While the alloy is effective at high temperatures, it is not capable of being heat treated using a conventional age hardening mechanism.

[0007] Heat treatable aluminum alloys strengthened by coherent $\rm L1_2$ intermetallic phases produced by standard, inexpensive melt processing techniques would be useful.

SUMMARY

[0008] The present invention is heat treatable aluminum alloys that can be cast, wrought, or formed by rapid solidification, and thereafter heat treated. The alloys can achieve high temperature performance and can be used at temperatures up to about 650° F. (343° C.).

[0009] These alloys comprise silicon, and an ${\rm Al_3X}$ L1₂ dispersoid where X is at least one first element selected from scandium, erbium, thulium, ytterbium, and lutetium, and at least one second element selected from gadolinium, yttrium, zirconium, titanium, hafnium, and niobium. The balance is substantially aluminum.

[0010] The alloys may also contain magnesium and, optionally, copper, and have less than 1.0 weight percent total impurities.

[0011] The alloys are formed by a process selected from casting, deformation processing and rapid solidification. The alloys are then heat treated at a temperature of from about 800° F. (426° C.) to about 1100° F. (593° C.) for between about 30 minutes and four hours, followed by quenching in water, and thereafter aged at a temperature from about 200° F. (93° C.) to about 600° F. (315° C.) for about two to forty eight hours.

BRIEF DESCRIPTION OF THE DRAWINGS

[0012] FIG. 1 is an aluminum silicon phase diagram.

[0013] FIG. 2 is an aluminum scandium phase diagram.

[0014] FIG. 3 is an aluminum erbium phase diagram.

[0015] FIG. 4 is an aluminum thulium phase diagram.

[0016] FIG. 5 is an aluminum ytterbium phase diagram.

[0017] FIG. 6 is an aluminum lutetium phase diagram.

DETAILED DESCRIPTION

[0018] The alloys of this invention are based on the aluminum silicon system. The aluminum silicon phase diagram is shown in FIG. 1. The binary system is a simple eutectic alloy system with a eutectic reaction at 12.5 weight percent silicon and 1077° F. (577° C.). There is little solubility of silicon in aluminum at temperatures up to 930° F. (500° C.) and none of aluminum in silicon. Hypoeutectic alloys with less than 12.6 weight percent silicon solidify with a microstructure consisting of primary aluminum grains in a finely divided aluminum/ silicon eutectic matrix phase. Hypereutectic alloys with silicon contents greater than the eutectic composition solidify with a microstructure of primary silicon grains in a finely divided aluminum/silicon eutectic matrix phase. Alloys of this invention include alloys with the addition of about 4 to about 25 weight percent silicon, more preferably about 4 to

about 18 weight percent silicon, and even more preferably about 5 to about 11 weight percent silicon.

[0019] Other alloys of this invention include aluminum silicon containing copper or magnesium, or both copper and magnesium. Copper and magnesium are completely soluble in aluminum in the compositions of the inventive alloys discussed herein. Aluminum copper and aluminum magnesium alloys are heat treatable with $Al_2Cu(\theta')$, $Al_2CuMg(S')$ and Sicrystals precipitating in aluminum-copper-silicon alloys; Mg₂Si and Si crystals precipitating in aluminum-magnesium-silicon alloys following a solution heat treatment, quench, and age process. In aluminum-copper-magnesiumsilicon alloys, strengthening phases are $Al_2Cu(\theta')$, Al_2CuMg (S'), Mg₂Si and Si crystals following a solution heat treatment, quench, and age process. $Mg_2Al_3(\beta)$ phase precipitates as large intermetallic particle in high magnesium containing aluminum alloys which is not desired from strengthening point of view. The presence of L₁, phase prevents formation of β phase in material which improves ductility and toughness of material. The alloys of this invention contain phases consisting of aluminum copper solid solutions, aluminum magnesium solid solutions, and aluminum copper magnesium solid solutions. In the solid solutions are dispersions of Al₃X having an L1₂ structure where X is at least one first element selected from scandium, erbium, thulium, ytterbium, and lutetium. Also present is at least one second element selected from gadolinium, yttrium, zirconium, titanium, hafnium, and niobium.

[0020] Exemplary aluminum alloys of this invention include but are not limited to (in weight percent):

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include, but are not limited to (in weight percent):
[0021]
        about Al-(4-25)Si-(0.1-0.5)Sc-(0.1-4)Gd;
        about Al-(4-25)Si-(0.1-6)Er-(0.1-4)Gd;
[0022]
[0023]
        about Al-(4-25)Si-(0.1-10)Tm-(0.1-4)Gd;
[0024]
        about Al-(4-25)Si-(0.1-15)Yb-(0.1-4)Gd;
[0025]
        about Al-(4-25)Si-(0.1-12)Lu-(0.1-4)Gd;
        about Al-(4-25)Si-(0.1-0.5)Sc-(0.1-4)Y;
[0026]
        about Al-(4-25)Si-(0.1-6)Er-(0.1-4)Y;
[0027]
[0028]
        about Al-(4-25)Si-(0.1-10)Tm-(0.1-4)Y;
[0029]
        about Al-(4-25)Si-(0.1-15)Yb-(0.1-4)Y;
[0030]
        about Al-(4-25)Si-(0.1-12)Lu-(0.1-4)Y;
[0031]
        about Al-(4-25)Si-(0.1-0.5)Sc-(0.05-1)Zr;
[0032]
        about Al-(4-25)Si-(0.1-6)Er-(0.05-1)Zr;
[0033]
        about Al-(4-25)Si-(0.1-10)Tm-(0.05-1)Zr;
[0034]
        about Al-(4-25)Si-(0.1-15)Yb-(0.05-1)Zr;
[0035]
        about Al-(4-25)Si-(0.1-12)Lu-(0.05-1)Zr;
[0036]
        about Al-(4-25)Si-(0.1-0.5)Sc-(0.05-2)Ti;
[0037]
        about Al-(4-25)Si-(0.1-6)Er-(0.05-2)Ti;
[0038]
        about Al-(4-25)Si-(0.1-10)Tm-(0.05-2)Ti;
[0039]
        about Al-(4-25)Si-(0.1-15)Yb-(0.05-2)Ti;
[0040]
        about Al-(4-25)Si-(0.1-12)Lu-(0.05-2)Ti;
[0041]
        about Al-(4-25)Si-(0.1-0.5)Sc-(0.05-2)Hf;
[0042]
        about Al-(4-25)Si-(0.1-6)Er-(0.05-2)Hf;
[0043]
        about Al-(4-25)Si-(0.1-10)Tm-(0.05-2)Hf;
[0044]
        about Al-(4-25)Si-(0.1-15)Yb-(0.05-2)Hf;
[0045]
        about Al-(4-25)Si-(0.1-12)Lu-(0.05-2)Hf;
[0046]
        about Al-(4-25)Si-(0.1-0.5)Sc-(0.05-1)Nb;
[0047]
        about Al-(4-25)Si-(0.1-6)Er-(0.05-1)Nb;
[0048]
        about Al-(4-25)Si-(0.1-10)Tm-(0.05-1)Nb;
[0049]
        about Al-(4-25)Si-(0.1-15)Yb-(0.05-1)Nb; and
[0050]
        about Al-(4-25)Si-(0.1-12)Lu-(0.05-1)Nb.
[0051] Examples of similar alloys to these are alloys with
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the addition of about 0.2 to about 3 weight percent Mg, more

preferably alloys with the addition of about 0.3 to about 1.5

weight percent Mg, and even more preferably alloys with the

addition of about 0.5 to about 1.5 weight percent Mg; and alloys with the addition of about 0.5 to about 5 weight percent Cu, more preferably alloys with the addition of about 1 to about 4 weight percent Cu, and even more preferably alloys with the addition of about 2 to about 4 weight percent Cu.

[0052] In the inventive aluminum based alloys disclosed herein, scandium, erbium, thulium, ytterbium, and lutetium are potent strengtheners that have low diffusivity and low solubility in aluminum. All these elements form equilibrium Al_3X intermetallic dispersoids where X is at least one of scandium, erbium, ytterbium, lutetium, that have an $L1_2$ structure that is an ordered face centered cubic structure with the X atoms located at the corners and aluminum atoms located on the cube faces of the unit cell.

[0053] Scandium forms Al₃Sc dispersoids that are fine and coherent with the aluminum matrix. Lattice parameters of aluminum and Al₃Sc are very close (0.405 nm and 0.410 nm respectively), indicating that there is minimal or no driving force for causing growth of the Al₃Sc dispersoids. This low interfacial energy makes the Al₃Sc dispersoids thermally stable and resistant to coarsening up to temperatures as high as about 842° F. (450° C.). Addition of magnesium in solid solution in aluminum increases the lattice parameter of the aluminum matrix, and decreases the lattice parameter mismatch further increasing the resistance of the Al₃Sc to coarsening. Addition of copper increases the strength of alloys through precipitation of $Al_2Cu(\theta')$ and $Al_2CuMg(S')$ phases. In the alloys of this invention these Al₃Sc dispersoids are made stronger and more resistant to coarsening at elevated temperatures by adding suitable alloying elements such as gadolinium, yttrium, zirconium, titanium, hafnium, niobium, or combinations thereof, that enter Al₃Sc in solution.

[0054] Erbium forms Al₃Er dispersoids in the aluminum matrix that are fine and coherent with the aluminum matrix. The lattice parameters of aluminum and Al₃Er are close (0.405 nm and 0.417 nm respectively), indicating there is minimal driving force for causing growth of the Al₃Er dispersoids. This low interfacial energy makes the Al₃Er dispersoids thermally stable and resistant to coarsening up to temperatures as high as about 842° F. (450° C.). Addition of magnesium in solid solution in aluminum increases the lattice parameter of the aluminum matrix, and decreases the lattice parameter mismatch further increasing the resistance of the Al₃Er to coarsening. Addition of copper increases the strength of alloys through precipitation of Al₂Cu (θ') and Al₂CuMg (S') phases. In the alloys of this invention, these Al₃Er dispersoids are made stronger and more resistant to coarsening at elevated temperatures by adding suitable alloying elements such as gadolinium, yttrium, zirconium, titanium, hafnium, niobium, or combinations thereof that enter Al₃Er in solution.

[0055] Thulium forms metastable Al₃Tm dispersoids in the aluminum matrix that are fine and coherent with the aluminum matrix. The lattice parameters of aluminum and Al₃Tm are close (0.405 nm and 0.420 nm respectively), indicating there is minimal driving force for causing growth of the Al₃Tm dispersoids. This low interfacial energy makes the Al₃Tm dispersoids thermally stable and resistant to coarsening up to temperatures as high as about 842° F. (450° C.). Addition of magnesium in solid solution in aluminum increases the lattice parameter of the aluminum matrix and decreases the lattice parameter mismatch further increasing the resistance to coarsening of the dispersoid. Addition of copper increases the strength of alloys through precipitation

of Al_2Cu (θ ') and Al_2CuMg (S') phases. In the alloys of this invention these Al_3Tm dispersoids are made stronger and more resistant to coarsening at elevated temperatures by adding suitable alloying elements such as gadolinium, yttrium, zirconium, titanium, hafnium, niobium, or combinations thereof that enter Al_3Tm in solution.

[0056] Ytterbium forms Al₃Yb dispersoids in the aluminum matrix that are fine and coherent with the aluminum matrix. The lattice parameters of Al and Al₃Yb are close (0.405 nm and 0.420 nm respectively), indicating there is minimal driving force for causing growth of the Al₃Yb dispersoids. This low interfacial energy makes the Al₃Yb dispersoids thermally stable and resistant to coarsening up to temperatures as high as about 842° F. (450° C.). Addition of magnesium in solid solution in aluminum increases the lattice parameter of the aluminum matrix and decreases the lattice parameter mismatch further increasing the resistance to coarsening of the Al₃Yb. Addition of copper increases the strength of alloys through precipitation of Al₂Cu (θ') and Al₂CuMg (S') phases. In the alloys of this invention, these Al₃Yb dispersoids are made stronger and more resistant to coarsening at elevated temperatures by adding suitable alloying elements such as gadolinium, yttrium, zirconium, titanium, hafnium, niobium, or combinations thereof that enter Al₃Yb in solution.

[0057] Lutetium forms Al₃Lu dispersoids in the aluminum matrix that are fine and coherent with the aluminum matrix. The lattice parameters of Al and Al₃Lu are close (0.405 nm and 0.419 nm respectively), indicating there is minimal driving force for causing growth of the Al₃Lu dispersoids. This low interfacial energy makes the Al₃Lu dispersoids thermally stable and resistant to coarsening up to temperatures as high as about 842° F. (450° C.). Addition of magnesium in solid solution in aluminum increases the lattice parameter of the aluminum matrix and decreases the lattice parameter mismatch further increasing the resistance to coarsening of Al₃Lu. Addition of copper increases the strength of alloys through precipitation of Al₂Cu (θ') and Al₂CuMg (S') phases. In the alloys of this invention, these Al₃Lu dispersoids are made stronger and more resistant to coarsening at elevated temperatures by adding suitable alloying elements such as gadolinium, yttrium, zirconium, titanium, hafnium, niobium, or mixtures thereof that enter Al₃Lu in solution.

[0058] Gadolinium forms metastable Al_3Gd dispersoids in the aluminum matrix that have an Ll_2 structure in the metastable condition. The Al_3Gd dispersoids are stable up to temperatures as high as about 842° F. (450° C.) due to their low diffusivity in aluminum. The Al_3Gd dispersoids have a $D0_{19}$ structure in the equilibrium condition. Despite its large atomic size, gadolinium has fairly high solubility in the Al_3X intermetallic dispersoids (where X is scandium, erbium, thulium, ytterbium or lutetium). Gadolinium can substitute for the X atoms in Al_3X intermetallic, thereby forming an ordered Ll_2 phase which results in improved thermal and structural stability.

[0059] Yttrium forms metastable Al_3Y dispersoids in the aluminum matrix that have an Ll_2 structure in the metastable condition and a $D0_{19}$ structure in the equilibrium condition. The metastable Al_3Y dispersoids have a low diffusion coefficient which makes them thermally stable and highly resistant to coarsening. Yttrium has a high solubility in the Al_3X intermetallic dispersoids allowing large amounts of yttrium to substitute for X in the Al_3X Ll_2 dispersoids which results in improved thermal and structural stability.

[0060] Zirconium forms Al_3Zr dispersoids in the aluminum matrix that have an Ll_2 structure in the metastable condition and $D0_{23}$ structure in the equilibrium condition. The metastable Al_3Zr dispersoids have a low diffusion coefficient which makes them thermally stable and highly resistant to coarsening. Zirconium has a high solubility in the Al_3X dispersoids allowing large amounts of zirconium to substitute for X in the Al_3X dispersoids, which results in improved thermal and structural stability.

[0061] Titanium forms Al_3Ti dispersoids in the aluminum matrix that have an $L1_2$ structure in the metastable condition and $D0_{22}$ structure in the equilibrium condition. The metastable Al_3Ti dispersoids have a low diffusion coefficient which makes them thermally stable and highly resistant to coarsening. Titanium has a high solubility in the Al_3X dispersoids allowing large amounts of titanium to substitute for X in the Al_3X dispersoids, which results in improved thermal and structural stability.

[0062] Hafnium forms metastable Al_3Hf dispersoids in the aluminum matrix that have an Ll_2 structure in the metastable condition and a $D0_{23}$ structure in the equilibrium condition. The Al_3Hf dispersoids have a low diffusion coefficient, which makes them thermally stable and highly resistant to coarsening. Hafnium has a high solubility in the Al_3X dispersoids allowing large amounts of hafnium to substitute for scandium, erbium, thulium, ytterbium, and lutetium in the above mentioned Al_3X dispersoids, which results in stronger and more thermally stable dispersoids.

[0063] Niobium forms metastable Al_3Nb dispersoids in the aluminum matrix that have an $L1_2$ structure in the metastable condition and a $D0_{22}$ structure in the equilibrium condition. Niobium has a lower solubility in the Al_3X dispersoids than hafnium or yttrium, allowing relatively lower amounts of niobium than hafnium or yttrium to substitute for X in the Al_3X dispersoids. Nonetheless, niobium can be very effective in slowing down the coarsening kinetics of the Al_3X dispersoids because the Al_3Nb dispersoids are thermally stable. The substitution of niobium for X in the above mentioned Al_3X dispersoids results in stronger and more thermally stable dispersoids.

[0064] Al₃X Ll₂ precipitates improve elevated temperature mechanical properties in aluminum alloys for two reasons. First, the precipitates are ordered intermetallic compounds. As a result, when the particles are sheared by glide dislocations during deformation, the dislocations separate into two partial dislocations separated by an anti-phase boundary on the glide plane. The energy to create the anti-phase boundary is the origin of the strengthening. Second, the cubic L1₂ crystal structure and lattice parameter of the precipitates are closely matched to the aluminum solid solution matrix. This results in a lattice coherency at the precipitate/matrix boundary that resists coarsening. The lack of an interphase boundary results in a low driving force for particle growth and resulting elevated temperature stability. Alloying elements in solid solution in the dispersed strengthening particles and in the aluminum matrix that tend to decrease the lattice mismatch between the matrix and particles will tend to increase the strengthening and elevated temperature stability of the alloy.

[0065] The amount of scandium present in the alloys of this invention if any may vary from about 0.1 to about 0.5 weight percent, more preferably from about 0.1 to about 0.35 weight percent, and even more preferably from about 0.1 to about 0.25 weight percent. The Al—Sc phase diagram shown in

FIG. 2 indicates a eutectic reaction at about 0.5 weight percent scandium at about 1219° F. (659° C.) resulting in a solid solution of scandium and aluminum and Al₃Sc dispersoids. Aluminum alloys with less than 0.5 weight percent scandium can be quenched from the melt to retain scandium in solid solution that may precipitate as dispersed L1₂ intermetallic Al₃Sc following an aging treatment. Alloys with scandium in excess of the eutectic composition (hypereutectic alloys) can only retain scandium in solid solution by rapid solidification processing (RSP) where cooling rates are in excess of about 10³° C./second.

[0066] The amount of erbium present in the alloys of this invention, if any, may vary from about 0.1 to about 6.0 weight percent, more preferably from about 0.1 to about 4 weight percent, and even more preferably from about 0.2 to 2 weight percent. The Al—Er phase diagram shown in FIG. 3 indicates a eutectic reaction at about 6 weight percent erbium at about 1211° F. (655° C.). Aluminum alloys with less than about 6 weight percent erbium can be quenched from the melt to retain erbium in solid solutions that may precipitate as dispersed L1₂ intermetallic Al₃Er following an aging treatment. Alloys with erbium in excess of the eutectic composition can only retain erbium in solid solution by rapid solidification processing (RSP) where cooling rates are in excess of about 10³° C./second. Alloys with erbium in excess of the eutectic composition (hypereutectic alloys) cooled normally will have a microstructure consisting of relatively large Al₃Er dispersoid in a finely divided aluminum-Al₃Er eutectic phase

[0067] The amount of thulium present in the alloys of this invention, if any, may vary from about 0.1 to about 10 weight percent, more preferably from about 0.2 to about 6 weight percent, and even more preferably from about 0.2 to about 4 weight percent. The Al-Tm phase diagram shown in FIG. 4 indicates a eutectic reaction at about 10 weight percent thulium at about 1193° F. (645° C.). Thulium forms metastable Al₃Tm dispersoids in the aluminum matrix that have an L1₂ structure in the equilibrium condition. The Al₃Tm dispersoids have a low diffusion coefficient which makes them thermally stable and highly resistant to coarsening. Aluminum alloys with less than 10 weight percent thulium can be quenched from the melt to retain thulium in solid solution that may precipitate as dispersed metastable L12 intermetallic Al3Tm following an aging treatment. Alloys with thulium in excess of the eutectic composition can only retain Tm in solid solution by rapid solidification processing (RSP) where cooling rates are in excess of about 10³° C./second.

[0068] The amount of ytterbium present in the alloys of this invention, if any, may vary from about 0.1 to about 15 weight percent more preferably from about 0.2 to about 8 weight percent, and even more preferably from about 0.2 to about 4 weight percent. The Al—Yb phase diagram shown in FIG. 5 indicates a eutectic reaction at about 21 weight percent ytterbium at about 1157° F. (625° C.). Aluminum alloys with less than about 21 weight percent ytterbium can be quenched from the melt to retain ytterbium in solid solution that may precipitate as dispersed L1₂ intermetallic Al₃Yb following an aging treatment. Alloys with ytterbium in excess of the eutectic composition can only retain ytterbium in solid solution by rapid solidification processing (RSP) where cooling rates are in excess of about 10³° C./second.

[0069] The amount of lutetium present in the alloys of this invention, if any, may vary from about 0.1 to about 12 weight percent, more preferably from 0.2 to about 8 weight percent,

and even more preferably from about 0.2 to about 4 weight percent. The Al—Lu phase diagram shown in FIG. 6 indicates a eutectic reaction at about 11.7 weight percent Lu at about 1202° F. (650° C.). Aluminum alloys with less than about 11.7 weight percent lutetium can be quenched from the melt to retain Lu in solid solution that may precipitate as dispersed L1₂ intermetallic Al₃Lu following an aging treatment. Alloys with Lu in excess of the eutectic composition can only retain Lu in solid solution by rapid solidification processing (RSP) where cooling rates are in excess of about 10³⁰ C./second.

[0070] The amount of gadolinium present in the alloys of this invention, if any, may vary from about 0.1 to about 4 weight percent, more preferably from 0.2 to about 2 weight percent, and even more preferably from about 0.5 to about 2 weight percent.

[0071] The amount of yttrium present in the alloys of this invention, if any, may vary from about 0.1 to about 4 weight percent, more preferably from 0.2 to about 2 weight percent, and even more preferably from about 0.5 to about 2 weight percent.

[0072] The amount of zirconium present in the alloys of this invention, if any, may vary from about 0.05 to about 1 weight percent, more preferably from 0.1 to about 0.75 weight percent, and even more preferably from about 0.1 to about 0.5 weight percent.

[0073] The amount of titanium present in the alloys of this invention, if any, may vary from about 0.05 to 2 about weight percent, more preferably from 0.1 to about 1 weight percent, and even more preferably from about 0.1 to about 0.5 weight percent

[0074] The amount of hafnium present in the alloys of this invention, if any, may vary from about 0.05 to about 2 weight percent, more preferably from 0.1 to about 1 weight percent, and even more preferably from about 0.1 to about 0.5 weight percent.

[0075] The amount of niobium present in the alloys of this invention, if any, may vary from about 0.05 to about 1 weight percent, more preferably from 0.1 to about 0.75 weight percent, and even more preferably from about 0.1 to about 0.5 weight percent.

[0076] In order to have the best properties for the alloys of this invention, it is desirable to limit the amount of other elements. Specific elements that should be reduced or eliminated include no more than about 0.1 weight percent iron, 0.1 weight percent chromium, 0.1 weight percent manganese, 0.1 weight percent vanadium, 0.1 weight percent cobalt, and 0.1 weight percent nickel. The total quantity of additional elements should not exceed about 1% by weight, including the above listed elements.

[0077] Other additions in the inventive alloys include at least one of about 0.001 weight percent to about 0.10 weight percent sodium, about 0.001 weight percent to about 0.10 weight percent calcium, about 0.001 to about 0.10 weight percent strontium, about 0.001 to about 0.10 weight percent antimony, 0.001 to 0.10 weight percent barium and about 0.001 to about 0.10 weight percent phosphorus. These are added to refine the microstructure of the eutectic phase and the primary silicon particle morphology and size.

[0078] These aluminum alloys may be made by any and all consolidation and fabrication processes known to those in the art such as casting (without further deformation), deformation processing (wrought processing), rapid solidification processing, forging, extrusion, rolling, die forging, powder metallurgy and others. The rapid solidification process should

have a cooling rate greater that about $10^{3\circ}$ C./second including but not limited to powder processing, atomization, melt spinning, splat quenching, spray deposition, cold spray, plasma spray, laser melting and deposition, ball milling and cryomilling.

[0079] Preferred exemplary aluminum alloys of this invention include, but are not limited to (in weight percent):

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[0080] about Al-(4-18)Si-(0.1-0.35)Sc-(0.2-2)Gd;
[0081]
        about Al-(4-18)Si-(0.1-4)Er-(0.2-2)Gd;
[0082]
        about Al-(4-18)Si-(0.2-6)Tm-(0.2-2)Gd;
[0083]
        about Al-(4-18)Si-(0.2-8)Yb-(0.2-2)Gd;
[0084]
        about Al-(4-18)Si-(0.2-8)Lu-(0.2-2)Gd;
[0085]
        about Al-(4-18)Si-(0.1-0.35)Sc-(0.2-2)Y;
[0086]
        about Al-(4-18)Si-(0.1-4)Er-(0.2-2)Y;
[0087]
        about Al-(4-18)Si-(0.2-6)Tm-(0.2-2)Y;
[8800]
        about Al-(4-18)Si-(0.2-8)Yb-(0.2-2)Y;
[0089]
        about Al-(4-18)Si-(0.2-8)Lu-(0.2-2)Y;
[0090]
        about Al-(4-18)Si-(0.1-0.35)Sc-(0.1-0.75)Zr;
[0091]
        about Al-(4-18)Si-(0.1-4)Er-(0.1-0.75)Zr;
[0092]
        about Al-(4-18)Si-(0.2-6)Tm-(0.1-0.75)Zr;
[0093]
        about Al-(4-18)Si-(0.2-8)Yb-(0.1-0.75)Zr;
[0094]
        about Al-(4-18)Si-(0.2-8)Lu-(0.1-0.75)Zr;
[0095]
        about Al-(4-18)Si-(0.1-0.35)Sc-(0.1-1)Ti;
[0096]
        about Al-(4-18)Si-(0.1-4)Er-(0.1-1)Ti;
[0097]
        about Al-(4-18)Si-(0.2-6)Tm-(0.1-1)Ti;
[0098]
        about Al-(4-18)Si-(0.2-8)Yb-(0.1-1)Ti;
[0099]
        about Al-(4-18)Si-(0.2-8)Lu-(0.1-1)Ti;
[0100]
        about Al-(4-18)Si-(0.1-0.35)Sc-(0.1-1)Hf;
[0101]
        about Al-(4-18)Si-(0.1-4)Er-(0.1-1)Hf;
[0102]
        about Al-(4-18)Si-(0.2-6)Tm-(0.1-1)Hf;
[0103]
        about Al-(4-18)Si-(0.2-8)Yb-(0.1-1)Hf;
        about Al-(4-18)Si-(0.2-8)Lu-(0.1-1)Hf;
[0104]
[0105]
        about Al-(4-18)Si-(0.1-0.35)Sc-(0.1-0.75)Nb;
[0106]
        about Al-(4-18)Si-(0.2-2)Er-(0.1-0.75)Nb;
[0107]
        about Al-(4-18)Si-(0.2-6)Tm-(0.1-0.75)Nb;
[0108]
        about Al-(4-18)Si-(0.2-8)Yb-(0.1-0.75)Nb; and
[0109]
        about Al-(4-18)Si-(0.2-8)Lu-(0.1-0.75)Nb.
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[0110] Examples of similar alloys to these are alloys with the addition of about 0.2-3 weight percent Mg, more preferably alloys with the addition of about 0.3-1.5 weight percent Mg, and even more preferably alloys with the addition of about 0.5-1.5 weight percent Mg; and alloys with the addition of about 0.5-5 weight percent Cu, more preferably alloys with the addition of about 1-4 weight percent Cu, and even more preferably alloys with the addition of about 2-4 weight percent Cu.

[0111] Even more preferred exemplary aluminum alloys of this invention include, but are not limited to (in weight percent):

```
about Al-(5-11)Si-(0.1-0.25)Sc-(0.5-2)Gd;
[0112]
[0113]
        about Al-(5-11)Si-(0.2-2)Er-(0.5-2)Gd;
[0114]
        about Al-(5-11)Si-(0.2-4)Tm-(0.5-2)Gd;
[0115]
        about Al-(5-11)Si-(0.2-4)Yb-(0.5-2)Gd;
[0116]
        about Al-(5-11)Si-(0.2-4)Lu-(0.5-2)Gd;
        about Al-(5-11)Si-(0.1-0.25)Sc-(0.5-2)Y;
[0117]
[0118]
        about Al-(5-11)Si-(0.2-2)Er-(0.5-2)Y;
[0119]
        about Al-(5-11)Si-(0.2-4)Tm-(0.5-2)Y;
[0120]
        about Al-(5-11)Si-(0.2-4)Yb-(0.5-2)Y;
[0121]
        about Al-(5-11)Si-(0.2-4)Lu-(0.5-2)Y;
[0122]
        about Al-(5-11)Si-(0.1-0.25)Sc-(0.1-0.5)Zr;
[0123]
        about Al-(5-11)Si-(0.2-2)Er-(0.1-0.5)Zr;
[0124]
        about Al-(5-11)Si-(0.2-4)Tm-(0.1-0.5)Zr;
[0125]
        about Al-(5-11)Si-(0.2-4)Yb-(0.1-0.5)Zr;
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about Al-(5-11)Si-(0.2-4)Lu-(0.1-0.5)Zr;

[0126]

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[0127] about Al-(5-11)Si-(0.1-0.25)Sc-(0.1-0.5)Ti;
[0128] about Al-(5-11)Si-(0.2-2)Er-(0.1-0.5)Ti;
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[0129] about Al-(5-11)Si-(0.2-4)Tm-(0.1-0.5)Ti;

[0130] about Al-(5-11)Si-(0.2-4)Yb-(0.1-0.5)Ti;

[0131] about Al-(5-11)Si-(0.2-4)Lu-(0.1-0.5)Ti;

[0132] about Al-(5-11)Si-(0.1-0.25)Sc-(0.1-0.5)Hf;

[0133] about Al-(5-11)Si-(0.2-2)Er-(0.1-0.5)Hf;

[0134] about Al-(5-11)Si-(0.2-4)Tm-(0.1-0.5)Hf; [0135] about Al-(5-11)Si-(0.2-4)Yb-(0.1-0.5)Hf;

[0136] about Al-(5-11)Si-(0.2-4)Lu-(0.1-0.5)Hf;

[0137] about Al-(5-11)Si-(0.1-0.25)Sc-(0.1-0.5)Nb;

[0138] about Al-(5-11)Si-(0.2-2)Er-(0.1-0.5)Nb;

[0139] about Al-(5-11)Si-(0.2-4)Tm-(0.1-0.5)Nb;

[0140] about Al-(5-11)Si-(0.2-4)Yb-(0.1-0.5)Nb; and

[0141] about Al-(5-11)Si-(0.2-4)Lu-(0.1-0.5)Nb.

[0142] Examples of similar alloys to these are alloys with the addition of about 0.2-3 weight percent Mg, more preferably alloys with the addition of about 0.3-1.5 weight percent Mg, and even more preferably alloys with the addition of about 0.5-1.5 weight percent Mg; and alloys with the addition of about 0.5-5 weight percent Cu, more preferably alloys with the addition of about 1-4 weight percent Cu, and even more preferably alloys with the addition of about 2-4 weight percent Cu.

[0143] Although the present invention has been described with reference to preferred embodiments, workers skilled in the art will recognize that changes may be made in form and detail without departing from the spirit and scope of the invention.

- 1. A method of forming a heat treatable aluminum alloy, the method comprising:
 - (a) forming a melt comprising:

about 4.0 to about 25.0 weight percent silicon;

about 0.2 to about 3.0 weight percent magnesium;

about 0.5 to about 5.0 weight percent copper;

- at least one first element selected from the group comprising about 0.1 to about 0.5 weight percent scandium, about 0.1 to about 6.0 weight percent erbium, about 0.1 to about 10 weight percent thulium, about 0.1 to about 15.0 weight percent ytterbium, and about 0.1 to about 12 weight percent lutetium;
- at least one second element selected from the group comprising about 0.1 to about 4.0 weight percent gadolinium, about 0.1 to about 4.0 weight percent yttrium, about 0.05 to about 1.0 weight percent zirconium, about 0.05 to about 2.0 weight percent titanium, about 0.05 to about 2.0 weight percent hafnium, and about 0.05 to about 1.0 weight percent niobium; and

the balance substantially aluminum;

- (b) solidifying the melt to form a solid body; and
- (c) heat treating the solid body.
- 2. The method of claim 1 further comprising:
- refining the structure of the solid body by deformation processing including at least one of: extrusion, forging and rolling.
- 3. The method of claim 1, wherein solidifying comprises a casting process.
- **4**. The method of claim **1**, wherein solidifying comprises a rapid solidification process in which the cooling rate is greater than about 10³° C./second including at least one of: powder processing, atomization, melt spinning, splat quenching, spray deposition, cold spray, plasma spray, laser melting and deposition, ball milling, and cryomilling.

 ${\bf 5}$. The method of claim ${\bf 1}$, wherein the heat treating comprises:

solution heat treatment at about 800° F. (426° C.) to about 1100° F. (593° C.) for about thirty minutes to four hours; and

quenching; and

aging at a temperature of about 200° F. (93° C.) to about 600° F. (315° C.) for about two to forty eight hours.

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